



Leading provider of high-end PCBs and IC substrates Well positioned for the future

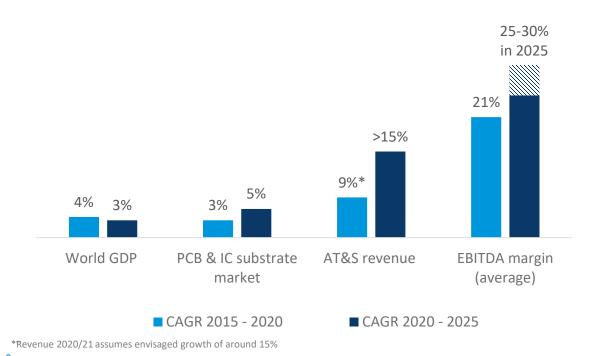


Unique market position

- Broad product portfolio to serve all growth markets
- Long-standing customer relationships with technology and market leaders
- Technology innovator due to continuous R&D efforts
- Quality benchmark with outstanding process know-how, productivity and efficiency
- Growth oriented strategy
 - Megatrend-driven markets with attractive growth potential
 - Address growth opportunities with incremental investments

An exciting growth story

AT&S with faster revenue growth than market





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Growing profitably with served markets



Expanding served markets

 IC substrates/modules: 11% market growth until 2025 ~ 15 % Revenue CAGR 2020 – 2025

25 – 30 %

EBITDA margin target

Growing market

- Technology leadership
- Operational excellence
- Strong customer engagement
- Clear focus on dedicated applications

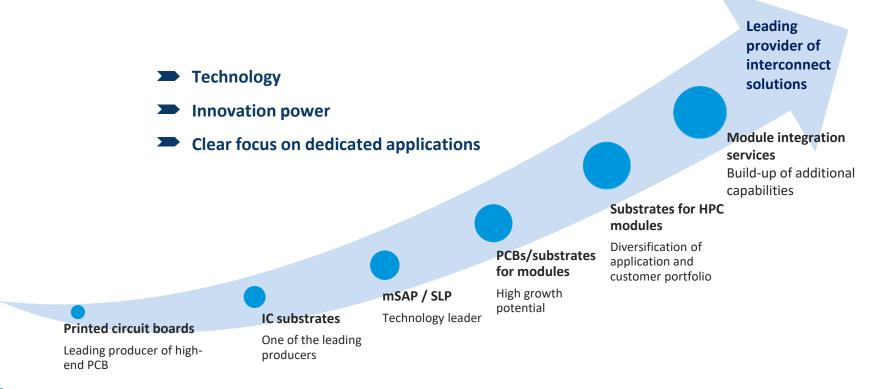
Strategy in execution

- IC substrates full expansion of capacities in CHQ I
- High-end PCBs full expansion of capacities in CHQ II
- IC substrates build-up of new capacities in CHQ III
- Further developing of PCB business to serve trends of modularization and miniaturization

More than AT&S



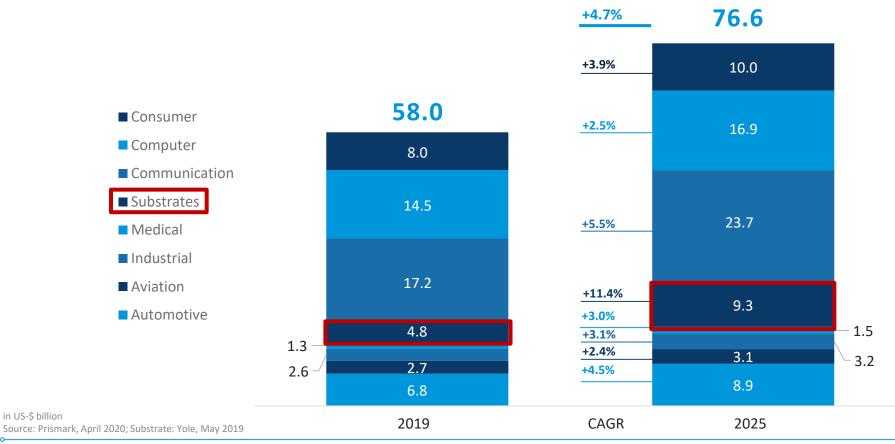
Broadening the service range and opening up of new business opportunities





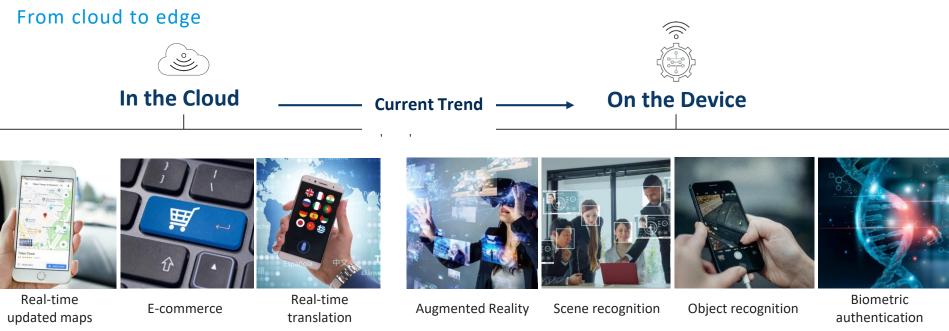
PCB & IC Substrates market outlook





Developments driving the IC substrates market growth





Connected devices: (4.6 % CAGR)

es: 201

2019: 42 billion units 2025: 55 billion units

Source: IDC (2019, 2020)

Developments driving the IC substrates market growth



High performance computers



Autonomous Driving

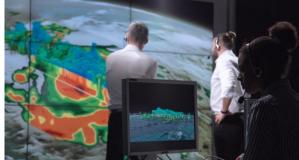


Genomics



Global Data Volume:

- 2019: 40 Zetabyte
- 2025: 175 Zetabyte → (27.9% CAGR)



Climate Research

Source: IDC (2019, 2020)



Vision Processor

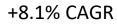
Global market leaders using ABF substrates

Global market leaders in microelectronics are driving the growth

High-end processor modules

2025: 1.88 billion units 2019: 1.18 billion units





Source: Prismark 2020

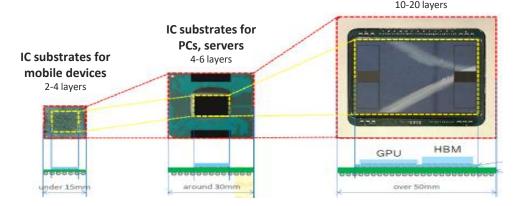
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High-end IC substrates

- ...have larger form factors due to more powerful processors modules
- ...have more build-up layers
- ...have a high speed interconnect between several semiconductors to provide high speed data transmission
- ...enable more complex packages than standard substrates
- ...reduce power consumption

High-end IC substrates market growth

2019: US-\$ 4.8 billion **2025:** US-\$ 9.3 billion (+11.4% CAGR)



Added Value for AT&S

- …push technology portfolio, profitability and revenue growth to a next level (mid-term: revenue target of € 2 billion, EBITDA margin of 25-30%)
- ...and thus increase value for AT&S, its customers and shareholders.

Source: Yole (2019

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IC substrates for AI, autonomous driving

On the way to become one of the leaders in high-end IC substrates AT&S

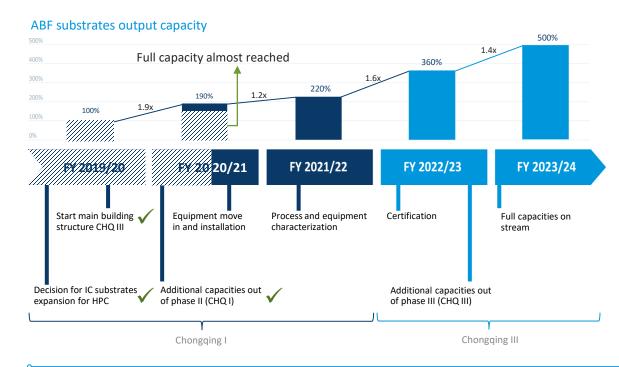


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IC substrates business in Chongqing I and III



Capacity expansion and technology investment pushed forward



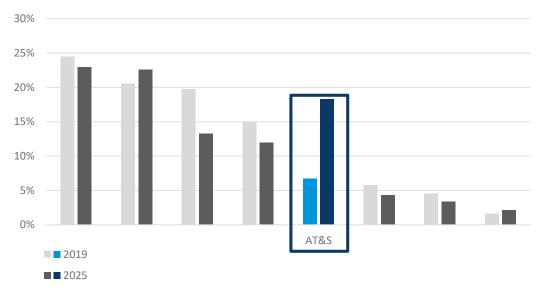
- CHQ I: Despite COVID-19 new capacities successfully ramped-up
- CHQ I: about 50% of additional capacity out of phase II will be reflected in revenues in 2020/21
- CHQ III: Roof closing already completed
- Covid-19 related construction delay of about six weeks
- Optimized infrastructure installation plan as well as the experience from CHQ I can compensate for the construction delay

Top-8 global ABF* substrates suppliers



AT&S expects to enter the top-league of ABF substrates suppliers and significantly increase output capacity by 2025

Output capacity by company (based on US-\$)



- ABF is the state-of-the-art production process for high-end IC substrates with high growth potential
- With current investments, AT&S will rise to the top three ABF suppliers globally by 2025

*ABF: Ajinomoto Buildup Film

Source: Prismark, JMS, AT&S assessment

Module business



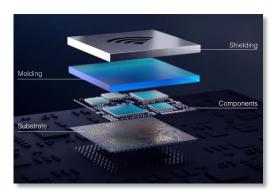
New opportunities through entry into the module market

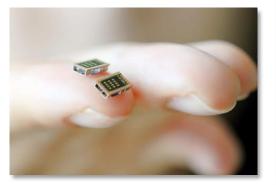
- Module integration market growing by 11% annually until 2025
 - Total investment Chongqing II in module business of about € 160 million
 - Extension of application and customer portfolio
 - Module PCB/substrates expected to reach ~5 – 10% of group revenues within the next two years
 - For FY 2020/21 already double-digit million revenue expected

Main applications include PCBs for RF/5G modules, power modules and wearables

Increase in **added value** through additional design, assembly and test services

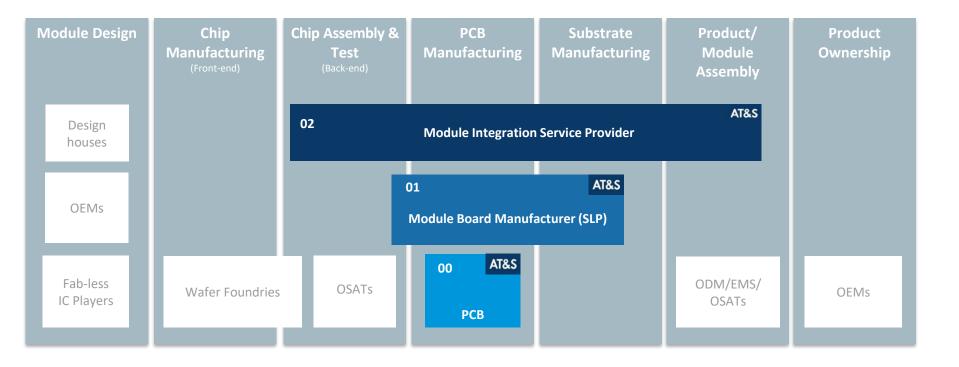






AT&S solutions for the electronics industry







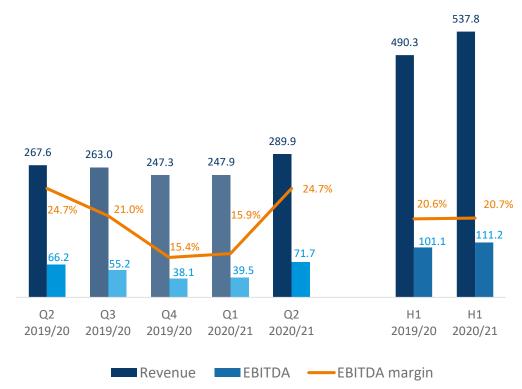
Development in H1 2020/21



AT&S with positive performance despite challenging environment

- IC substrates business profits from successful ramp-up of new capacities in CHQ I and strong demand for ABF substrates
- Customer and application diversification compensates for delayed smartphone launches in Mobile Devices
- Decrease in vehicle sales weighs on Automotive segment, but sequentially improved
- Industrial segment profits from better product mix
- Medical & Healthcare with solid demand in Q2, but could not compensate for Q1 development

Revenue and EBITDA development



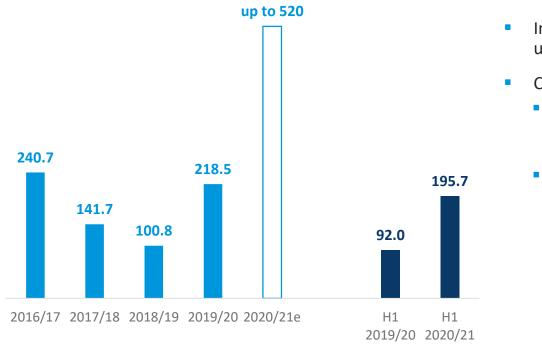
- Strong revenue increase despite slightly negative currency effects
- EBITDA increased to € 111.2 million (PY: € 101.1 million) supported by higher revenue
- Future technology generations require higher R&D spending
- Net profit lower at € 14.7 million (PY: € 19.5 million) driven by currency effects and negative interest result
- Operating free cash flow at € -112.1 million (PY: € -29.8 million) due to higher investment activity

in € millions

Net CAPEX



Investments in IC substrates and module business to be consistently continued



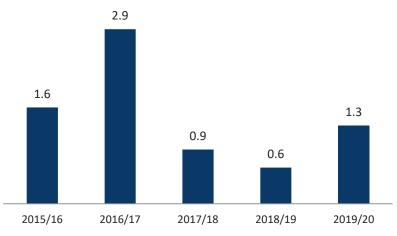
- Investments in IC substrates and technology upgrades still driver for increase
- Capex outlook 2020/21:
 - Depending on market developments CAPEX for maintenance and tech-upgrade of up to € 80 million
 - CAPEX for strategic projects of up to € 410 million plus € 30 million due to timing variances

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in € millions

Solid finance structure

Net debt/EBITDA



in € million

*Liquid funds include unused credit lines of 425.5 million €; as of 30.09.2020

Existing funds and cash flow generation help to meet repayments and capex needs

< 3

Net debt / EBITDA target

951.7

million € of existing liquid funds*





Outlook for 2020/21



AT&S has managed crisis successfully and positively participates in intact trends

- Future trends not harmed by COVID-19 pandemic
- Expectations for customer demand for the current year
- Demand for IC substrates remains strong according to current forecasts
- Due to delayed product launches, demand for mobile devices shifted into FQ3, usual seasonality expected for FQ4
- Automotive market shows signs of bottoming out, slightly positive trend visible
- Industrial segment to remain at the level of previous year
- Slight growth expected for medical applications
- FY 2020/21: Revenue growth of around 15% and an EBITDA margin in the range of 20 to 22%
- Based on strong H1, a solid order situation in FQ3 and successful ramp-up of additional capacities in CHQ I
- Assuming no major impact of COVID 19 on key markets, production facilites and supply chain
- Investment programme for FY 2020/21 unchanged

Medium-term guidance confirmed



Technology development to module integration and capacity expansion

Expansion of technology leadership

- Leading provider of new interconnect solutions
- Innovation revenue rate: > 20%

Focus on continued profitable growth

- Revenue target of € 2 billion
- Prosecution of sustainable margin improvement
- Medium-term EBITDA margin target of 25-30%

Creation of shareholder value and robust financial structure

- Medium-term ROCE above 12%
- Net debt / EBITDA: < 3 / Equity ratio: > 40% / Average Finance costs: < 2%</p>

Sustainability management

- 80% renewable energy
- Eco-balancing of product groups
- 30 % women in management positions

First choice

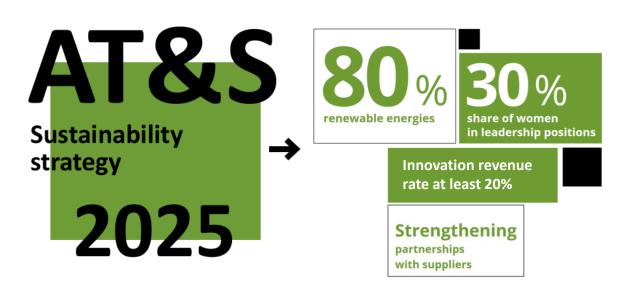
for advanced

applications



Driving sustainability

High level of social, ecological and economic responsibility



Achievements in 2019/20

- Savings of 13.4 GWh or 10.9 kt of CO2
- Share of women in leadership positions of 21%
- Innovation revenue rate of 30.8%
- 95% of suppliers signed our Code of Conduct



External ESG recognition of Best-in-Class performance

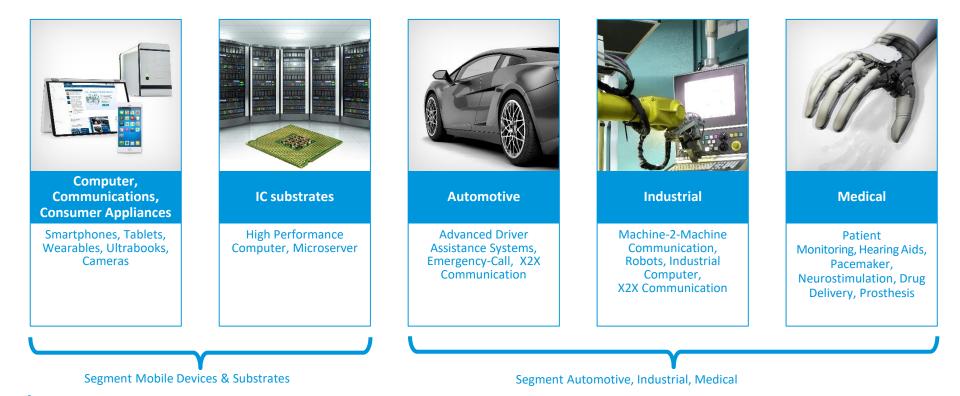


Rated by		Committed to			
	Outperformer 2019 Overall Score: 77		RBA (Responsible Business Alliance)	STATES STATES	Responsible Minerals Initiative
ISS-oekom>	Prime 2019 Corporate Responsibility: B-		SDGs (Sustainable Development Goals)	Jun -	OECD guidelines
MSCI 🛞	BBB 2020 ESG rating		ILO (International Labour Organization)	ISO	ISO (International Organization for Standardization)
CDP	Climate ChangeWater Security2020: B-2020: BManagementManagement		Austrian diversity charter		

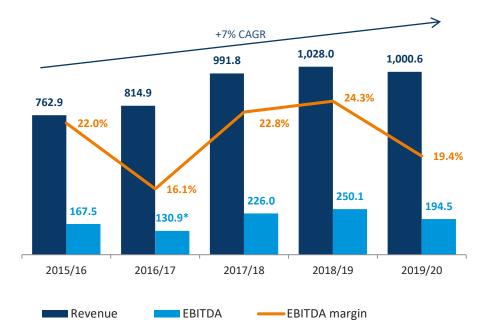


Market Segments & Product Applications

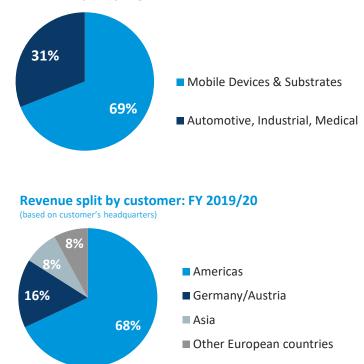




Key facts FY 2019/20



Revenue split by segment: FY 2019/20



€ in millions _*Based on ramp-up effects for new plants in China

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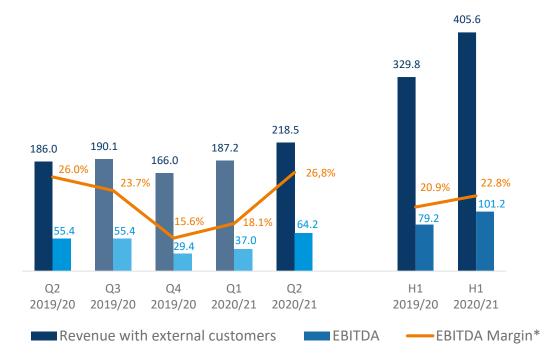


Market position HDI Technology (2019)

Rank	Supplier	Country/Region	HDI (revenue in US-\$ millions)
1	Compeq	TWN	776
2	AT&S	AUT	736
3	TTM	USA	716
4	Unimicron	TWN	706
5	Tripod	TWN	508
6	Meiko	JPN	461
7	Zhen Ding	TWN	428
8	Korea Circuit	KOR	227
9	Founder PCB	CHN	222
10	СМК	JPN	220

Business development – Mobile Devices & Substrates





- IC substrates performance above expectations driven by strong ABF demand and better product mix
- Customer and application diversification compensates for delayed smartphone launches in Mobile Devices

in ${\ensuremath{\varepsilon}}$ millions; *Margin calculated from total business unit revenue

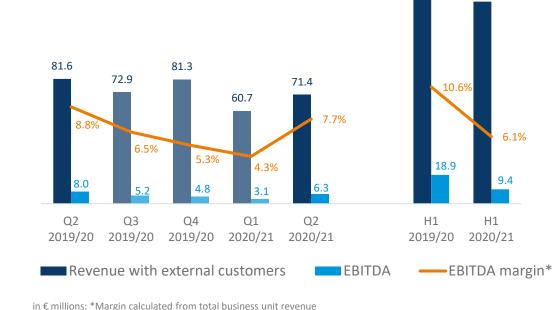
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Business development – Automotive, Industrial, Medical

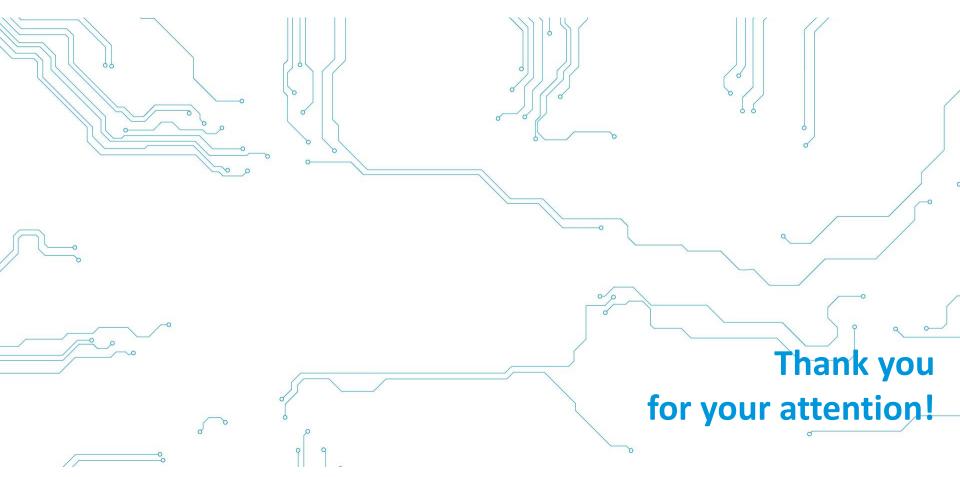
160.6

132.1

- Industrial segment with satisfying development supported by better product mix
- Automotive segment impacted by decrease in vehicle sales, but sequentially improved
- Medical & Healthcare with flat revenue development in Q2
- Profitability lower due to decreased demand, underutilization of related production facilities and resulting lower fixed cost coverage







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